

**Product Summary** (@T<sub>A</sub> = +25°C)

V <sub>RRM</sub> (V)	I <sub>o</sub> (A)	V <sub>F</sub> (V)	I <sub>R</sub> (μA)
1000	10	1.1	10

**Features and Benefits**

- Glass Passivated Die Construction
- Low-Forward Voltage Drop and High-Current Capability
- Surge Overload Rating to 250A Peak
- Ideally Suited for Automated Assembly
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The S10CMHQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.**

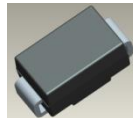
<https://www.diodes.com/quality/product-definitions/>

**Description and Applications**

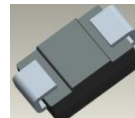
10.0A Surface-Mount Glass Passivated Rectifier in SMC package, offers high-current capability and low-forward voltage drop.

**Mechanical Data**

- Package: SMC
- Package Material: Molded Plastic.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 <sup>ⓐ</sup>
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.21 grams (Approximate)

**SMC**


Top View

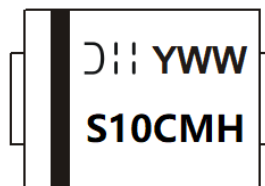


Bottom View

**Ordering Information** (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
S10CMHQ-13	SMC	3,000	Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

**Marking Information**


S10CMH = Product Type Marking Code  
 DII = Manufacturers' Code Marking  
 YWW = Date Code Marking  
 Y = Last Digit of Year (ex: 4 for 2024)  
 WW = Week Code (01 to 52)

**Maximum Ratings** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	1,000	V
RMS Reverse Voltage	$V_{R(RMS)}$	700	V
Average Rectified Output Current @ $T_T = +75^\circ\text{C}$	$I_O$	10.0	A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load @ $T_J = +25^\circ\text{C}$	$I_{FSM}$	250	A
Non-Repetitive Peak Forward Surge Current, 1.0ms Single Half Sine-Wave Superimposed on Rated Load @ $T_J = +25^\circ\text{C}$	$I_{FSM}$	500	A
$I^2t$ Rating for Fusing ( $t < 8.3\text{ms}$ )	$I^2t$	259.38	$\text{A}^2\text{S}$

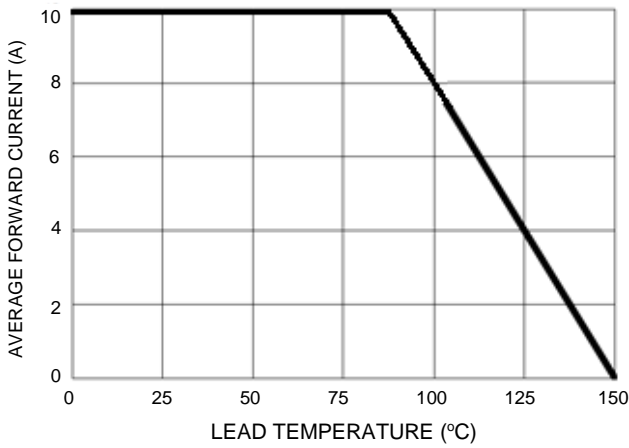
**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	8	$^\circ\text{C/W}$
Typical Thermal Resistance, Junction to Terminal (Note 6)	$R_{\theta JT}$	13	$^\circ\text{C/W}$
Typical Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	46	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	$^\circ\text{C}$

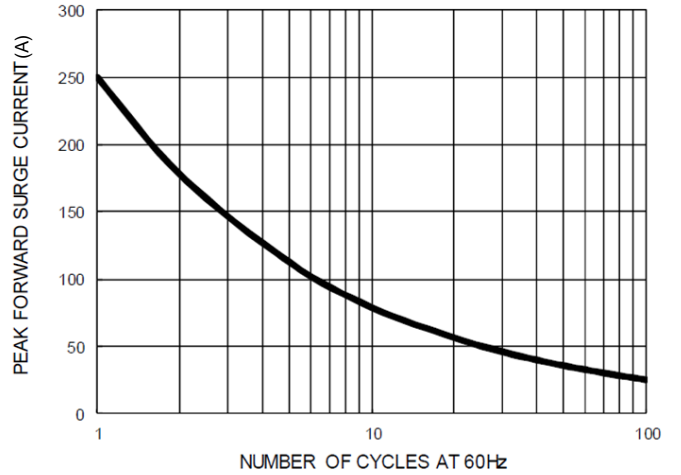
**Electrical Characteristics** (@  $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Minimum Reverse Breakdown Voltage @ $I_R = 1\mu\text{A}$	$V_{(BR)R}$	1,000	V
Maximum Forward Voltage @ $I_F = 10.0\text{A}$	$V_{FM}$	1.1	V
Peak Reverse Current @ $T_A = +25^\circ\text{C}$ @ $T_A = +125^\circ\text{C}$	$I_{RM}$	10 250	$\mu\text{A}$
Typical Total Capacitance (Note 5)	$C_T$	75	pF

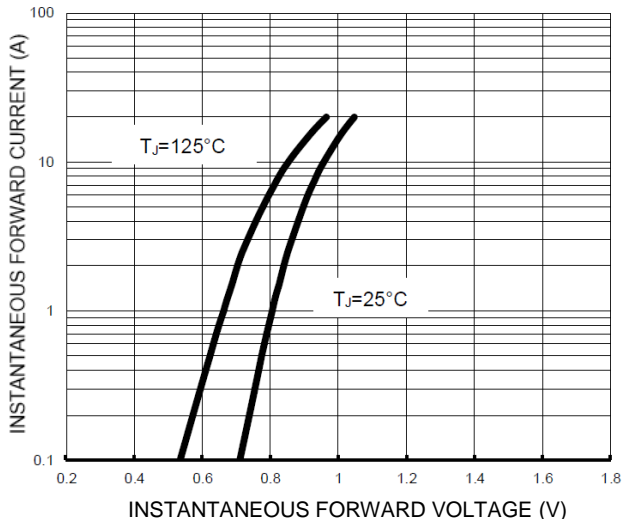
Notes: 5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
6. Thermal resistance measured without heat sink attached.



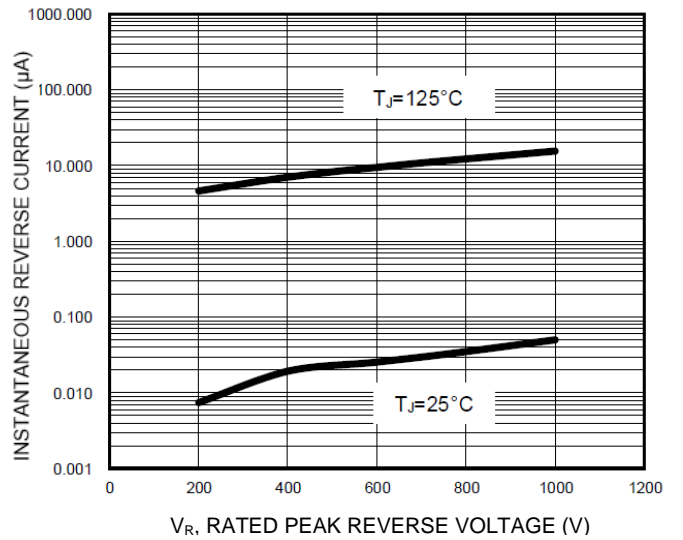
**FIG.1- FORWARD CURRENT DERATING CURVE**



**FIG.2- MAXIMUM NON-REPETITIVE SURGE CURRENT**



**FIG.3- TYPICAL FORWARD CHARACTERISTICS**

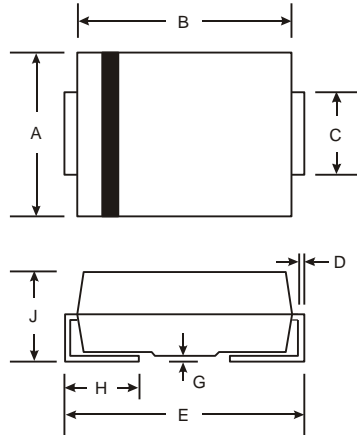


**FIG.4- TYPICAL REVERSE CHARACTERISTICS**

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### SMC

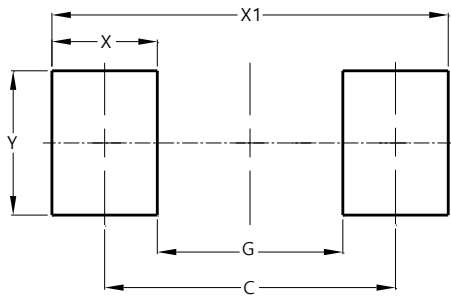


SMC		
Dim	Min	Max
A	5.59	6.22
B	6.60	7.11
C	2.75	3.18
D	0.15	0.31
E	7.75	8.13
G	0.10	0.20
H	0.76	1.52
J	2.00	2.50
All Dimensions in mm		

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### SMC



Dimensions	Value (in mm)
C	6.90
G	4.40
X	2.50
X1	9.40
Y	3.30

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